

#### **Description**

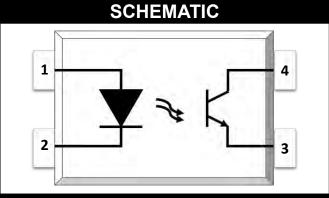
The TD817(TK) series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar medium speed photo transistor detqector in a plastic DIP4 package with different lead forming options. With the robust coplanar double mold structure, TD817(TK) series provide the most stable isolation feature.

#### **Features**

- High isolation 5000 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range 55 °C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
  - UL UL1577
  - VDE EN60747-5-5(VDE0884-5)
  - CQC GB4943.1, GB8898
  - cUL- CSA Component Acceptance
     Service Notice No. 5A

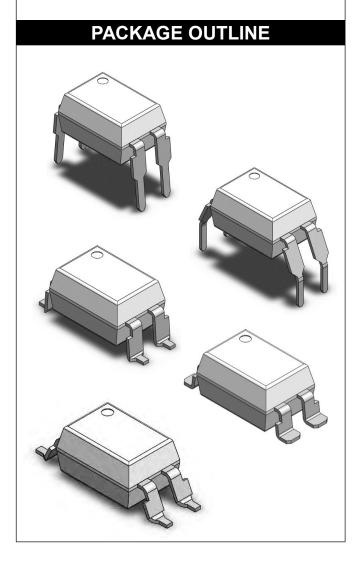
#### **Applications**

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment



#### **PIN DEFINITION**

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector





| ABSOLUTE MAXIMUM RATINGS    |                  |         |      |      |  |  |  |
|-----------------------------|------------------|---------|------|------|--|--|--|
| PARAMETER                   | SYMBOL           | VALUE   | UNIT | NOTE |  |  |  |
| INPUT                       |                  |         |      |      |  |  |  |
| Forward Current             | I <sub>F</sub>   | 60      | mA   |      |  |  |  |
| Peak Forward Current        | I <sub>FP</sub>  | 1       | Α    | 1    |  |  |  |
| Reverse Voltage             | V <sub>R</sub>   | 6       | V    |      |  |  |  |
| Input Power Dissipation     | Pı               | 100     | mW   |      |  |  |  |
| OUTPUT                      |                  |         |      |      |  |  |  |
| Collector - Emitter Voltage | V <sub>CEO</sub> | 60      | V    |      |  |  |  |
| Emitter - Collector Voltage | V <sub>ECO</sub> | 5       | V    |      |  |  |  |
| Collector Current           | Ic               | 50      | mA   |      |  |  |  |
| Output Power Dissipation    | Po               | 150     | mW   |      |  |  |  |
| COMMON                      |                  |         |      |      |  |  |  |
| Total Power Dissipation     | Ptot             | 200     | mW   |      |  |  |  |
| Isolation Voltage           | Viso             | 5000    | Vrms | 2    |  |  |  |
| Operating Temperature       | Topr             | -55~110 | °C   |      |  |  |  |
| Storage Temperature         | Tstg             | -55~125 | °C   |      |  |  |  |
| Soldering Temperature       | Tsol             | 260     | °C   |      |  |  |  |

Note 1. 100 $\mu s$  pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. =  $40 \sim 60\%$ 

# LIGHTNING

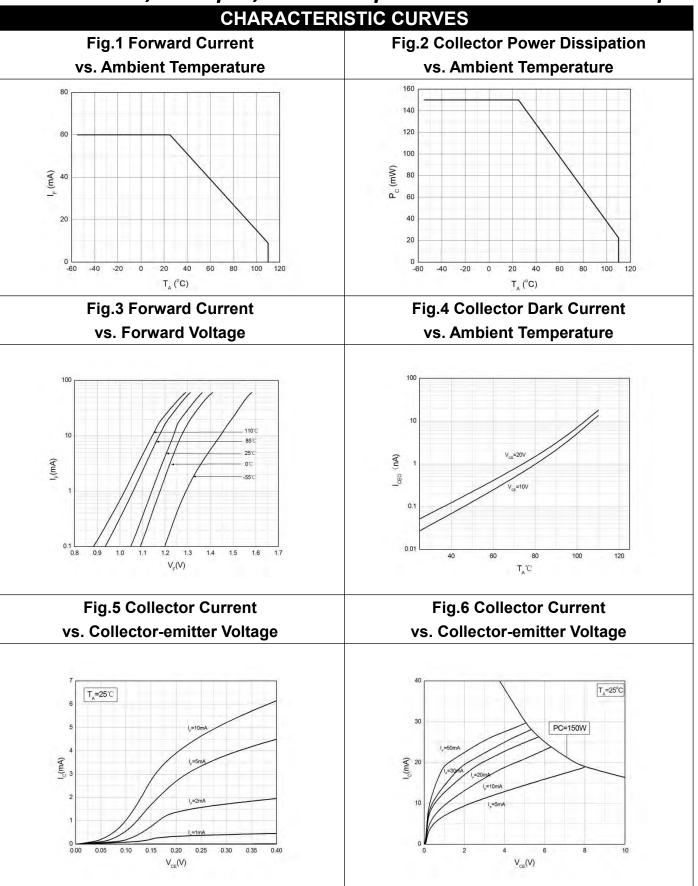
### DIP4, DC input, medium speed Photo transistor coupler

| ELECTI                               | RICAL O              | PTICA | L CHA | ARAC | TER  | ISTICS at Ta=25°C              |      |
|--------------------------------------|----------------------|-------|-------|------|------|--------------------------------|------|
| PARAMETER                            | SYMBOL               | MIN   | TYP.  | MAX. | UNIT | TEST CONDITION                 | NOTE |
| INPUT                                |                      |       |       |      |      |                                |      |
| Forward Voltage                      | V <sub>F</sub>       | -     | 1.24  | 1.4  | V    | IF=10mA                        |      |
| Reverse Current                      | I <sub>R</sub>       | -     | -     | 10   | μA   | VR=6V                          |      |
| Input Capacitance                    | Cin                  | -     | 10    | 100  | pF   | V=0, f=1kHz                    |      |
| OUTPUT                               |                      |       |       |      |      |                                |      |
| Collector Dark Current               | I <sub>CEO</sub>     | -     | -     | 100  | nA   | VCE=20V, IF=0                  |      |
| Collector-Emitter Breakdown Voltage  | BV <sub>CEO</sub>    | 60    | -     | -    | V    | IC=0.1mA, IF=0                 |      |
| Emitter-Collector Breakdown Voltage  | BV <sub>ECO</sub>    | 5     | -     | -    | V    | IE=0.1mA, IF=0                 |      |
| TRANSFER CHARACTERISTICS             |                      |       |       |      |      |                                |      |
| Current Transfer<br>Ratio            | CTR                  | 50    | -     | 600  | %    | IF=5mA, VCE=5V                 |      |
| Collector-Emitter Saturation Voltage | V <sub>CE(sat)</sub> | -     | 0.09  | 0.3  | V    | IF=20mA, IC=1mA                |      |
| Isolation Resistance                 | R <sub>ISO</sub>     | 10^12 | 10^14 | -    | Ω    | DC500V, 40 ~ 60% R.H.          |      |
| Floating Capacitance                 | C <sub>IO</sub>      | -     | 0.4   | 1    | pF   | V=0, f=1MHz                    |      |
| Response Time (Rise)                 | tr                   | -     | 2.8   | 18   | μs   | VCE=2V, IC=2mA                 | 3    |
| Response Time (Fall)                 | tf                   | -     | 1.3   | 18   | μs   | RL=100Ω                        | 3    |
| Cut-off Frequency                    | fc                   | -     | 80    | -    | kHz  | VCE=2V, IC=2mA<br>RL=100Ω,-3dB | 4    |

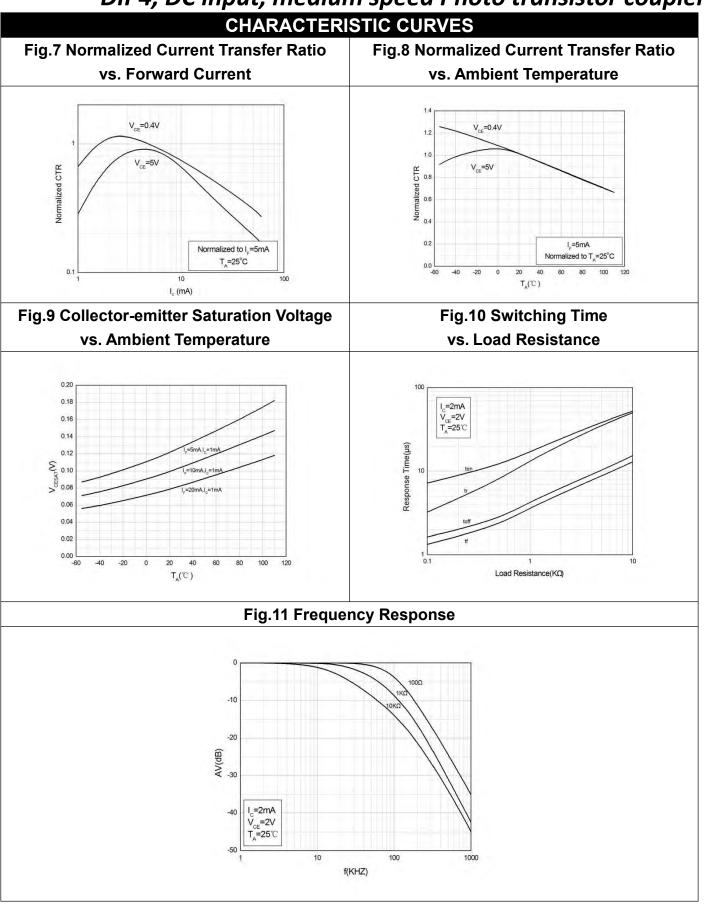
Note 3. Fig.12&13

Note 4. Fig.14

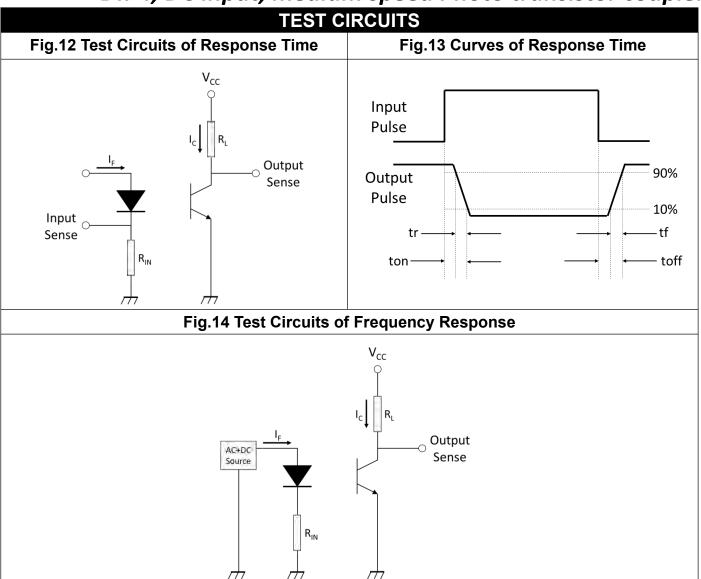






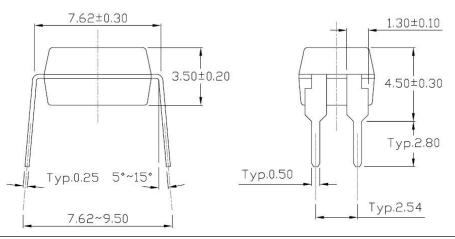




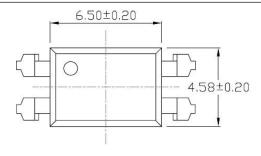


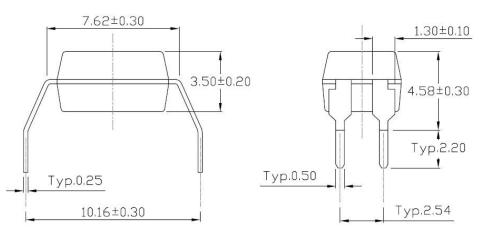


## PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated) Standard DIP - Through Hole (DIP Type) 6.50±0.20 4.58±0.20

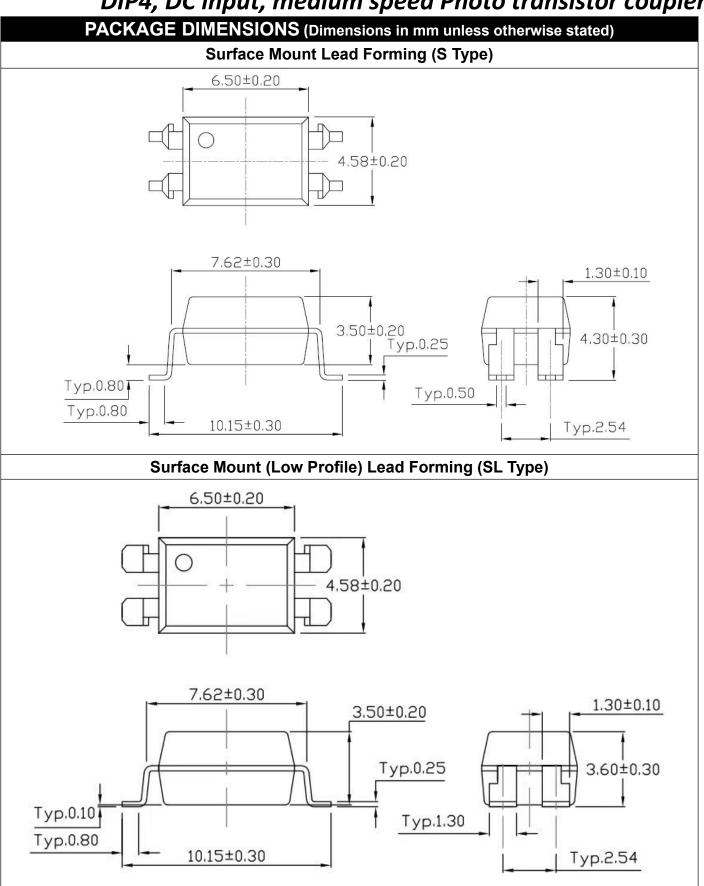


#### Gullwing (400mil) Lead Forming - Through Hole (M Type)





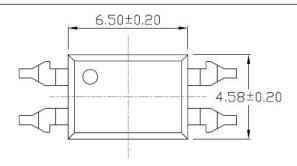


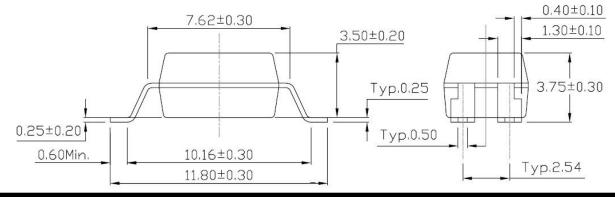




#### PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

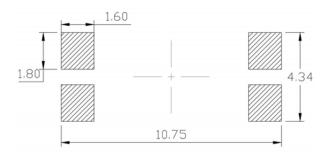
Surface Mount (Gullwing) Lead Forming (SLM Type)



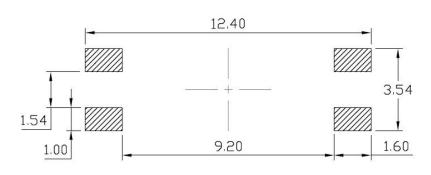


#### RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

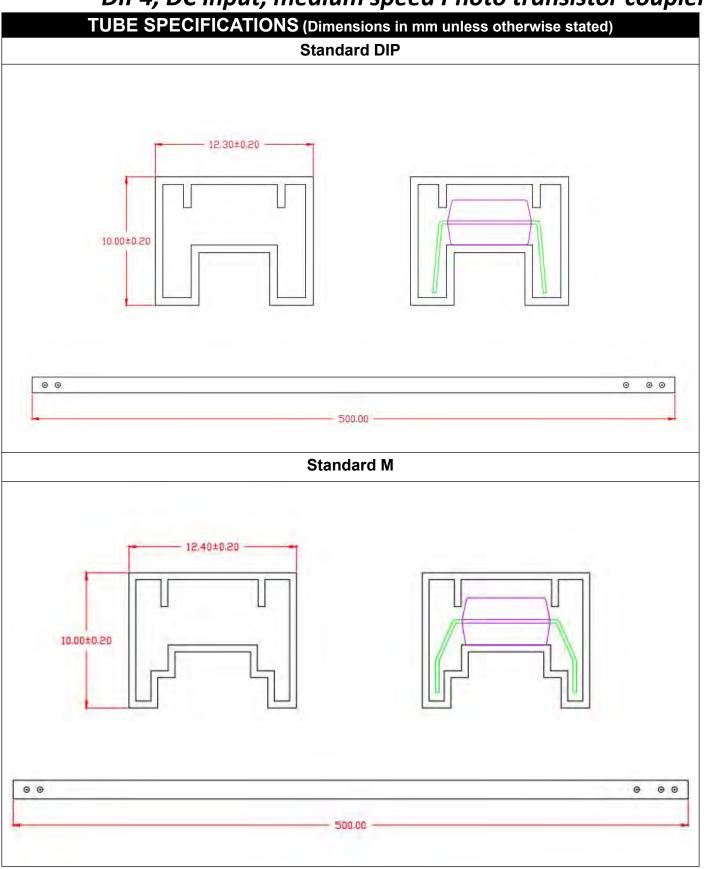
Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming



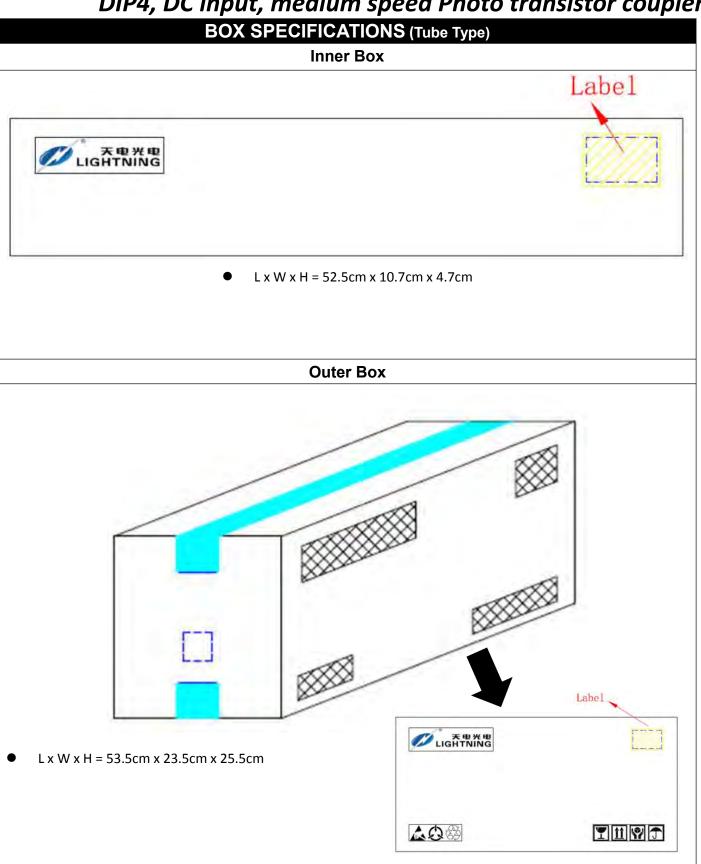
#### **Surface Mount (Gullwing) Lead Forming**





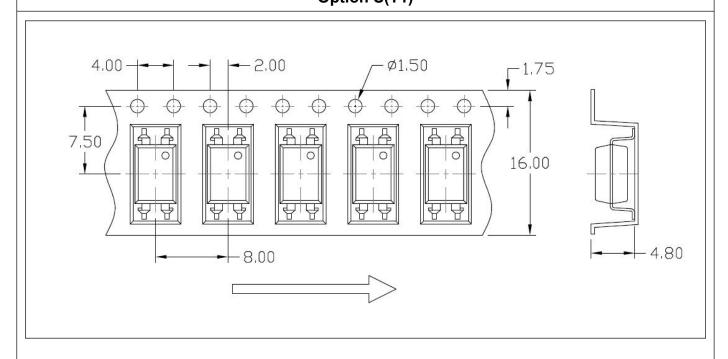




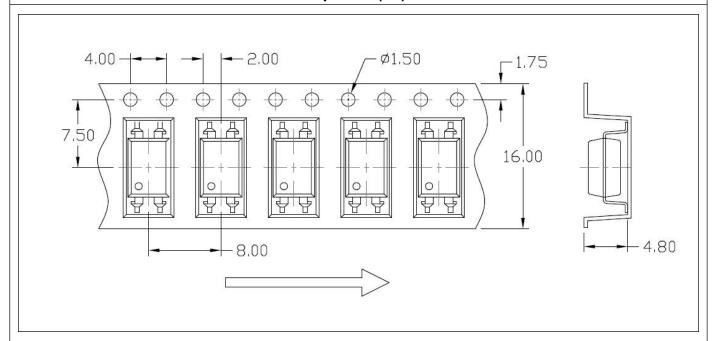




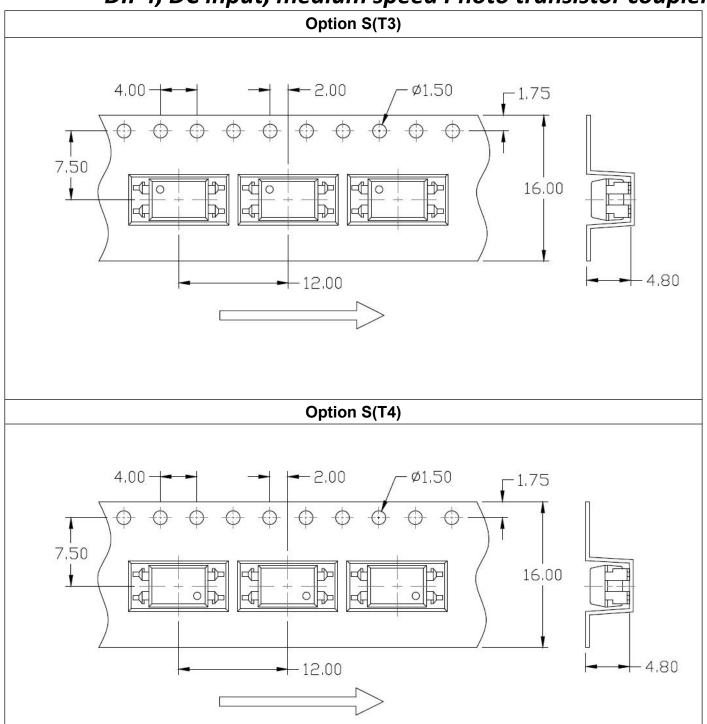
# CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated) Option S(T1)



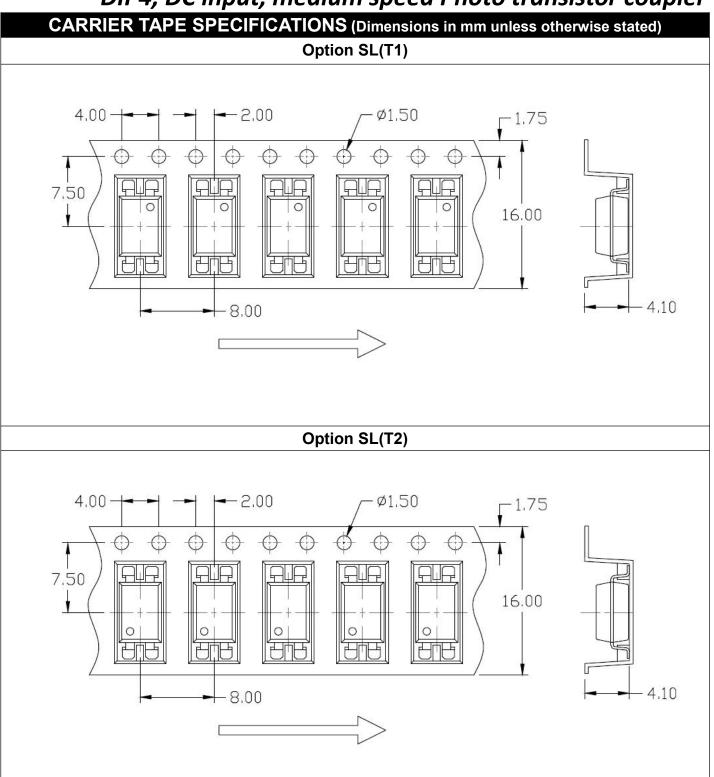
#### Option S(T2)





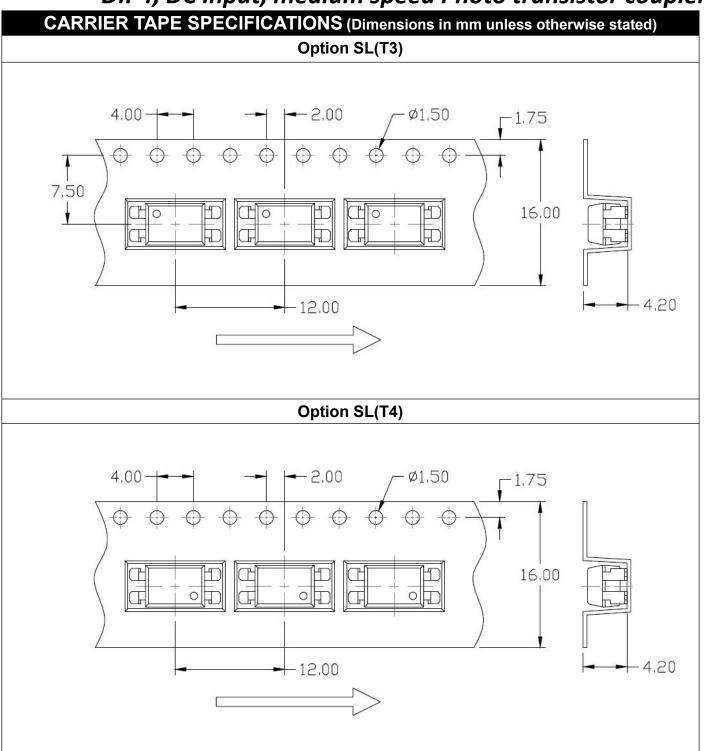




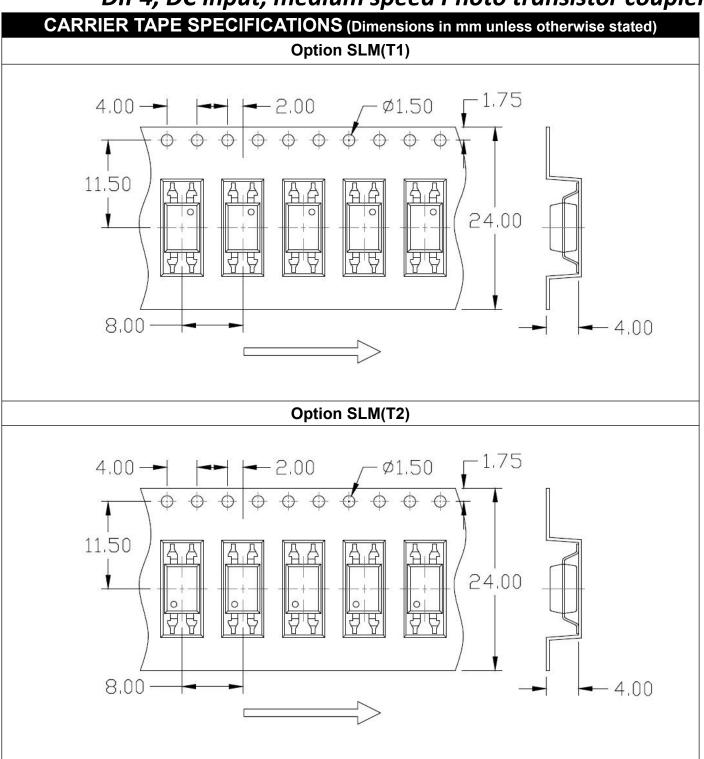




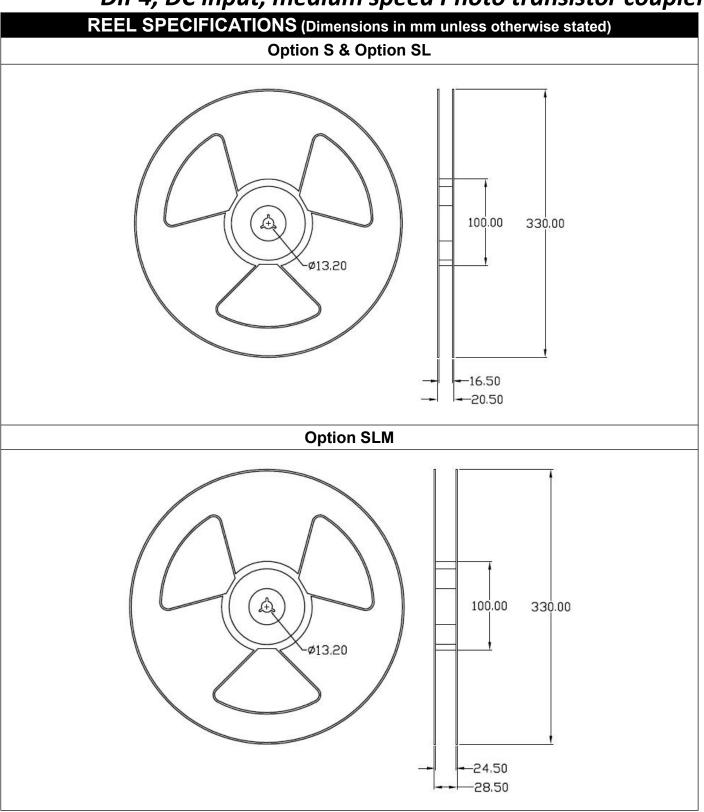




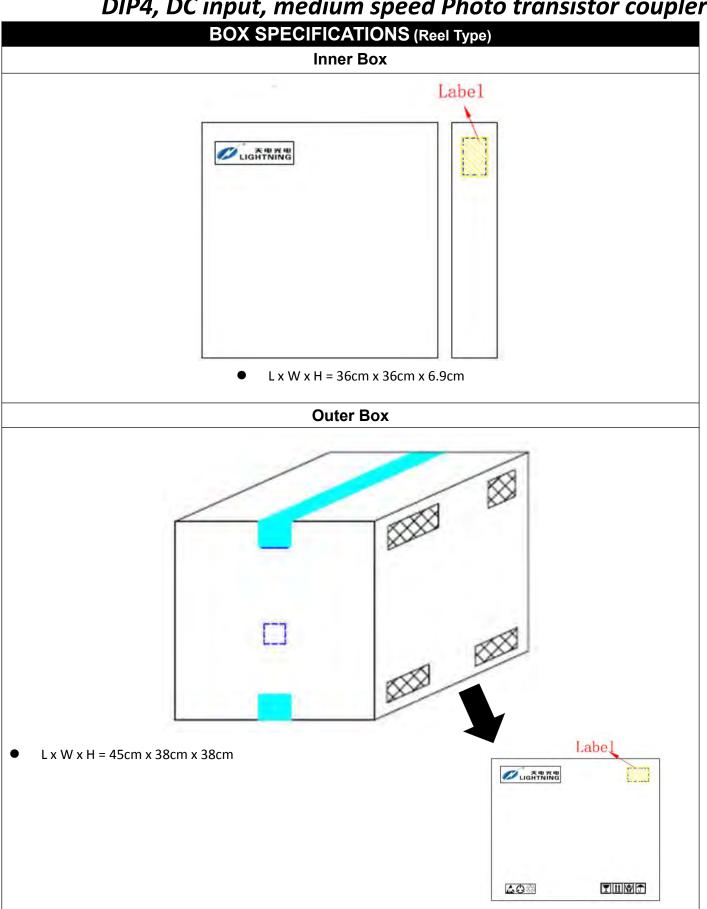














#### ORDERING AND MARKING INFORMATION

#### MARKING INFORMATION



TD : Company Abbr.

817 : Part Number

X : CTR Rank

: Leadframe Option

: VDE Option V Υ : Fiscal Year

: Manufacturing Code

ww : Work Week

ORDERING INFORMATION

### TD817X(Y)(Z)-FGV(TK)

TD - Company Abbr.

817 – Part Number

X – Rank (A/B/C/D/E/F or None)

Y – Lead Form Option (M/S/SL/SLM/None)

Z – Tape and Reel Option (T1/T2/T3/T4)

F – Leadframe Option (F:Iron, None:Copper)

G - Green

V – VDE Option (V or None)



LABEL INFORMATION

Date Code: XXXX

QTY: XXXX PCS



Made in QuanZhou FuJian







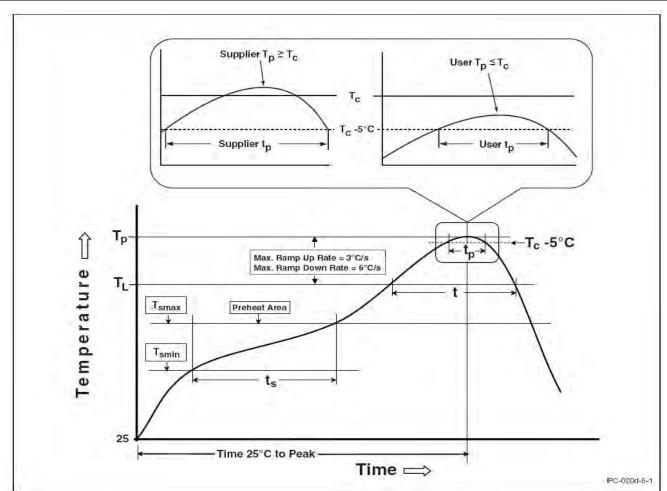


#### Packing Quantity

| Facking Quantity |                 |                      |                                     |  |
|------------------|-----------------|----------------------|-------------------------------------|--|
| Option           | Quantity        | Quantity - Inner box | Quantity – Outer box                |  |
| None             | 100 Units/Tube  | 32 Tubes/Inner box   | 10 Inner box/Outer box = 32k Units  |  |
| М                | 100 Units/Tube  | 32 Tubes/Inner box   | 10 Inner box/Outer box = 32k Units  |  |
| S(T1)            | 1500 Units/Reel | 3 Reels/Inner box    | 5 Inner box/Outer box = 22.5k Units |  |
| S(T2)            | 1500 Units/Reel | 3 Reels/Inner box    | 5 Inner box/Outer box = 22.5k Units |  |
| S(T3)            | 1000 Units/Reel | 3 Reels/Inner box    | 5 Inner box/Outer box = 15k Units   |  |
| S(T4)            | 1000 Units/Reel | 3 Reels/Inner box    | 5 Inner box/Outer box = 15k Units   |  |
| SL(T1)           | 1500 Units/Reel | 3 Reels/Inner box    | 5 Inner box/Outer box = 22.5k Units |  |
| SL(T2)           | 1500 Units/Reel | 3 Reels/Inner box    | 5 Inner box/Outer box = 22.5k Units |  |
| SL(T3)           | 1000 Units/Reel | 3 Reels/Inner box    | 5 Inner box/Outer box = 15k Units   |  |
| SL(T4)           | 1000 Units/Reel | 3 Reels/Inner box    | 5 Inner box/Outer box = 15k Units   |  |
| SLM(T1)          | 1500 Units/Reel | 2 Reels/Inner box    | 5 Inner box/Outer box = 15k Units   |  |
| SLM(T2)          | 1500 Units/Reel | 2 Reels/Inner box    | 5 Inner box/Outer box = 15k Units   |  |
|                  |                 |                      |                                     |  |

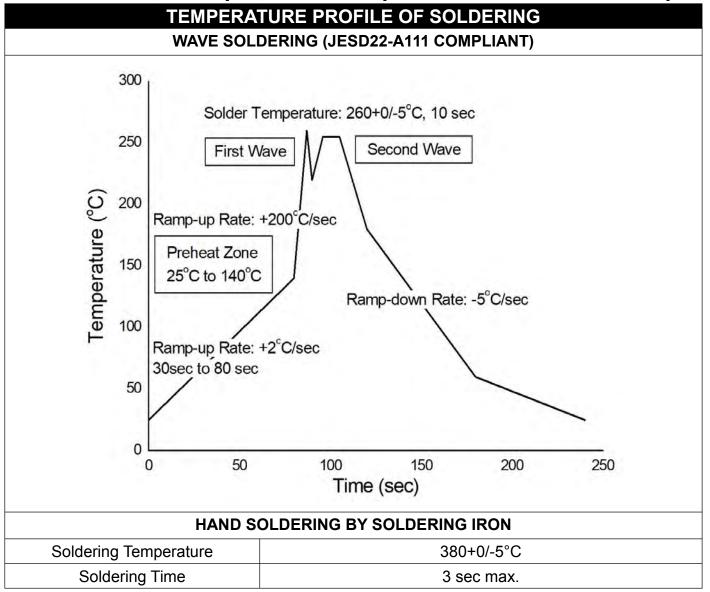


# REFLOW INFORMATION REFLOW PROFILE



| Profile Feature                 | Sn-Pb Assembly Profile | Pb-Free Assembly Profile |
|---------------------------------|------------------------|--------------------------|
| Temperature Min. (Tsmin)        | 100                    | 150°C                    |
| Temperature Max. (Tsmax)        | 150                    | 200°C                    |
| Time (ts) from (Tsmin to Tsmax) | 60-120 seconds         | 60-120 seconds           |
| Ramp-up Rate (tL to tP)         | 3°C/second max.        | 3°C/second max.          |
| Liquidous Temperature (TL)      | 183°C                  | 217°C                    |
| Time (tL) Maintained Above (TL) | 60 – 150 seconds       | 60 – 150 seconds         |
| Peak Body Package Temperature   | 235°C +0°C / -5°C      | 260°C +0°C / -5°C        |
| Time (tP) within 5°C of 260°C   | 20 seconds             | 30 seconds               |
| Ramp-down Rate (TP to TL)       | 6°C/second max         | 6°C/second max           |
| Time 25°C to Peak Temperature   | 6 minutes max.         | 8 minutes max.           |





- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



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